## FOREWORD

## Special Section on Recent Development of Electro-Mechanical Devices

This special section mainly focuses on the recent development of Electro-Mechanical Devices. Many papers in this issue were presented in 17th International Session on Electro-Mechanical Devices (IS-EMD2017) which is supported by the technical committee of EMD. IS-EMD2017 was held in the University of Electro-Communications, Tokyo, Japan on November 17th, 2017.

Seventeen years ago, International session on EMD was established as a meeting to open the discussion for the research results in IEICE with foreign researchers. One of the results of meeting has been published as the special section in the transaction of IEICE for more than 14 years. The special issue has been well-known among the worldwide EMD people.

Basically, the committee of Electromechanical Devices is established as a research meeting to resolve a lot of problems which support a new concept on the subject of mechanical components including all of the related electrical and mechanical issues. Around 20 years ago, the mechanical means have been expanded on the research fields such as mechanical contact of the optical components and other fields. Now a day, the issues in EMD include Basic Contact Phenomena, Theoretical Analysis, Arc Discharge and Related Phenomena, Sliding contacts, Relays, Connectors, Contactors and Circuit Breakers, Optical Interconnection, Sensing Devices, Automotive Applications, Signal Transmission, Lead Free Soldering, Reduce-Reuse-and-Recycle Techniques, Testing and Evaluation, and Others. These fields have been wellknown subjects from early research fields on electrical and electronic engineering, but there are lots of still unresolved problems not only for available traditional matters but for newly developed applications.

In this section, 1 paper and 1 brief paper are selected from 9 submitted papers. These papers include wide basic research fields which are interesting for the readers who have basic electrical engineering research issues.

Lastly, I would like to express great appreciation to the Editorial Committee, especially Prof. Masato Mizukami and Dr. Yoshiteru Abe, Guest Editors, for the remarkable contribution to editorial task of this special section.

Special Section Editorial Committee

Guest Editors: Masato Mizukami (Muroran Inst. of Tech.), Yoshiteru Abe (NTT)

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**Ryo Nagase** (*Fellow*) received B.E., M.E. and Ph. D. degrees in precision engineering from Tohoku University, Miyagi, Japan, in 1983, 1985, and 1998, respectively. In 1985, he joined NTT Laboratories, Nippon Telegraph and Telephone Corp. From 1985 to 2009, He has been engaged in research and development of optical fiber connectors. From Oct., 2009, he is a professor of precision engineering at Chiba Institute of Technology, Chiba, Japan. His current interests are microscopic deformation and optical remote-sensing. He is an Expert of IEC TC86/SC86B and a member of IEEE and the Japan Society of Mechanical Engineers (JSME).

